	BLE STAN			Q	torage				
	Operating Temperature Range 2 Voltage Current		Signal Contact : 50 V AC Tter Power Contact : 200 V AC Stor Signal Contact : 0.5 A Stor		Femperature Range -10 °C to Storage Humidity Range		-10 °C to 6	-10 °C to 60 °C ⁽²⁾ Relative humidity 85% max	
Rating							-		
			SPEC	IFICATION	٧S				
IT	EM		TEST METHOD			REQUI	IREMENTS	QT	A
CONSTRL	JCTION	•			•				
General Examination		Visually and by measuring instrument.			According to drawing.			×	>
Marking		Confirmed visually.							;
ELECTRIC CHARAC									
Contact Resistance		100 mA(DC or 1000Hz)			Signal Contact : $70m \Omega$ MAX. Power Contact : $20m \Omega$ MAX.			×	-
Insulation Resistance		Signal Contact : 100 V DC. Power Contact : 250 V DC			Signal Contact : 100 MΩMIN. Power Contact : 1000 MΩMIN.			×	-
Voltage Proof		Signal Contact : 150 V AC for 1 min.			No flashover or breakdown.			×	>
		Power Contact : 600 V AC for 1 min.			INO IIAS				-
	CAL CHAR								
Insertion and		Measured by applicable connector.				Insertion Force: 45 N MAX.			-
Withdrawal Forces		100 times insertions and sutrasticity				Withdrawal Force: 5 N MIN.			_
Mechanical Operation		100 times insertions and extractions.			S	 Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. No damage, crack and looseness of parts. 			
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude : 0.75 mm, 10 cycles			① No	 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 			-
Shock		for 3 axial directions. 490 m/s ² , duration of pulse 11 ms			_	-		×	-
			for 3 both axial directions.						
	MENTAL C								
Damp Heat (Steady state)		Exposed at 40±2 °C, 90 ~ 95 %, 96 h.			① Contact Resistance: Signal Contact : 80m Ω MAX.			×	-
Rapid Change of Temperature		Temperature $-55 \rightarrow +85 \circ C$ Time $30 \rightarrow 30$ min.			Power Contact : 30m Ω MAX. ② Insulation Resistance: Signal Contact : 100 MΩ MIN.			×	-
		under 5 cycles. (Relocation time to chamber : within 2~3 MIN)			F	Power Contact	: 1000 MΩ MIN.		
Cold		Exposed at -55°C, 96 h			③ No damage, crack and looseness of parts. ① Contact Resistance: × Signal Contact : 80m Ω MAX.			×	-
Dry Heat		Exposed at 105°C, 96 h						×	-
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h. (Test standard: IEC 68)			 No defect such as corrosion which impairs the function of connector. Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. 			×	+ -
Resistance to		1)Reflow soldering :			No deformation of case of excessive			×	1-
Soldering Heat		Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec			loosene	looseness of the terminal.			
<u></u>			g irons : 360°C MAX. for 5	SEC.	<u> </u>			×	_
Solderability		Soldered at solder temperature $240\pm3^{\circ}$ C for immersion duration, 3 sec.			minimu	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.			-
		SCRIPTIO	N OF REVISIONS		GNED		CHECKED		
COUN			-00002064	-	OONO		HT. YAMAGUCHI	17.0	
COUN	¹ Include temperature rise caused by current-carrying.		13.		APPROVED	HS. OKAWA	14.0		
2 2	¹⁾ Include temper	ature rise canes	 (2) "STORAGE" means a long-term storage state for the unused product before assembly to PCB. 					14.0	
2 REMARKS	²⁾ "STORAGE" me	eans a long-ter	m storage state for the unused pro			DECIONIES	KN. SHIBUYA	44.4	
2 REMARKS	²⁾ "STORAGE" me before assembl	eans a long-teri ly to PCB.				DESIGNED	TS. OONO	14.0	
2 REMARKS	²⁾ "STORAGE" m before assembl erwise speci	eans a long-ter ly to PCB. fied, refer t	o IEC 60512.			DRAWN	TS. 00N0 TS. 00N0	14.0)7.2
2 REMARKS	²⁾ "STORAGE" me before assemble erwise speci Jalification Te	eans a long-tern ly to PCB. fied, refer t st AT:Assu		est D	DRAWIN T NO.	DRAWN IG NO.	TS. OONO	14.0)7.2